APPLICATION DATA SHEET

Electronic Version v14

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Title of Invention

Printed Circuit Board with Isolated Metallic Substrate Comprising an Integrated Cooling System

Application Type: regular, utility 8134FS

Attorney Docket Number :

Correspondence address:

Customer Number: 23688

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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith

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